

EMP110 HR

HIGH RESOLUTION AQUEOUS DEVELOPABLE LIQUID PHOTOIMAGEABLE SOLDERMASK

Carapace® EMP110 HR is a high resolution, contact exposure, aqueous developing, liquid photoimageable soldermask, using two-component epoxy technology to give high levels of chemical resistance over copper, copper oxide, tin-lead or gold plated circuits. Owing to their, high dielectric strength and physical resistance properties, Carapace® soldermasks are used as solder resists and insulation coverings on all types of printed circuits, in particular, high-reliability, double-sided and multilayer, fine line, surface mount boards.

The new high resolution **HR** series have been developed to enable PCB manufacturers to meet today's demands for fine pitch circuitry.

FEATURES & BENEFITS

- High resolution 50µ, solder dam capability
- High resistance to low solids fluxes
- Electroless Nickel/immersion gold compatibility
- Low ionic contamination
- High moisture and insulation resistance
- "Halogen Free" versions available.

CARAPACE® EMP10 HR is available in the following range of colours, finishes and application methods:-

Colours: Light green (LG), Blue, (B), Finishes: Gloss, Matt, Extra Matt

Application Methods: Screen print (SP), Curtain Coat (CC), Airspray (AS) and Electrostatic Spray (ES)

PERFORMANCE:

UL 94

Specification

Opecification	Result	
SM840C	Pass - Class H	
Telcordia GR-78 (formerly Bellcore)	Pass	
MIL5110D	Pass	
Siemens E Korrosion	Pass	

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Pass - V0

TML - 0.95% (with UV bump)

 Property
 Result

 Pencil Hardness
 9H

 Dielectric Strength
 85kV per mm

 Dielectric Loss
 0.03 (@ 1Mhz)

 Dielectric constant
 4 (@1Mhz)

 CTI
 660 deg per km

 Outgassing
 TML - 2.58% (no UV bump)

